# **S1A THRU S1M**

SURFACE MOUNT GLASS PASSIVATED SILICON RECTIFIER

REVERSE VOLTAGE: FORWARD CURRENT:

## 50 to 1000 VOLTS 1.0 AMPERE

#### http://www.njzrg.com

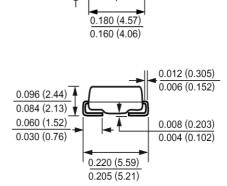
GROWCI

#### FEATURES

- $\cdot$  For surface mounted applications
- $\cdot$  Low profile package
- $\cdot$  Built-in strain relief
- · Easy pick and place
- · Low forward voltage drop
- · Plastic package has Underwriters Laboratory
- Flammability Classification 94V-O
- $\cdot$  High temperature soldering : 260°C /10 seconds at terminals

#### MECHANICAL DATA

Case: Molded plastic, DO-214AA(SMB) Terminals: Solder plated, solderable per MIL-STD-750, method 2026 guaranteed Polarity: Color band denotes cathode end Packaging: 12mm tape per EIA STD RS-481 Weight: 0.003 ounce, 0.093 gram



Dimensions in inches and (millimeters)

### Maximum Ratings and Electrical Characteristics

Ratings at 25 ambient temperature unless otherwise specified. Single phase, half wave,  $60H_Z$ , resistive or inductive load. For capacitive load, derate current by 20%.

	Symbols	S1A	S1B	S1D	S1G	S1J	S1K	S1M	Units
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at T <sub>L</sub> =100	I <sub>(AV)</sub>		•	•	1.0	•	•	•	Amp
Peak Forward Surge Current,									
8.3ms single half-sine-wave	I <sub>FSM</sub>	I <sub>FSM</sub> 30							Amp
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage at 1.0A	V <sub>F</sub>	1.1							Volts
Maximum Reverse Current at T <sub>A</sub> =25	T	I <sub>R</sub> 5.0 100							μАтр
at Rated DC Blocking Voltage T <sub>A</sub> =125	IR								
Typical Junction Capacitance (Note 1)	CJ	12							pF
Typical Thermal Resistance (Note 2)	R <sub>0JL</sub>	30							/W
Maximum Reverse Recovery Time (Note 3)	T <sub>RR</sub>	2.5							μS
Operating Junction Temperature Range	T <sub>J</sub>	-55 to +150							
Storage Temperature Range	Tstg	-55 to +150							

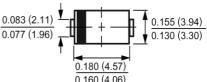
#### NOTES:

1- Measured at 1  $MH_Z$  and applied reverse voltage of 4.0 VDC.

2- Thermal resistance from junction to lead mounted on P.C.B. with 0.3 x 0.3" (8.0 x 8.0mm) copper pad areas

3- Reverse Recovery Test Conditions :  $I_{F} {=} .5 A$  ,  $I_{R} {=} 1 A$  ,  $I_{RR} {=} .25 A.$ 

DO214-AA(SMB)

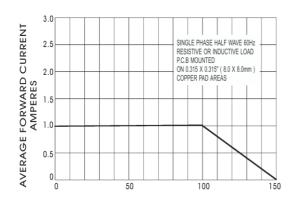


## RATINGS AND CHARACTERISTIC CURVES

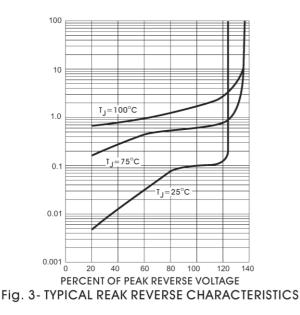
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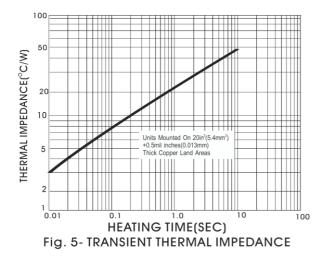
GROWCHILD

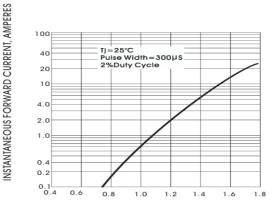
ELECTRONICS



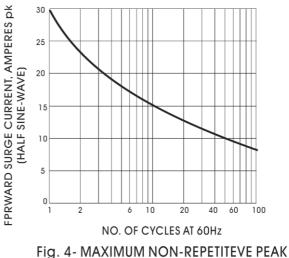








INSTANTANEOUS FORWARD VOLTAGE, VOLTS Fig. 2- TYPICAL INSTANTANEOUS FORWARD CHARACTERISITCS PER ELEMENT



FORWARD SURGE CURRENT

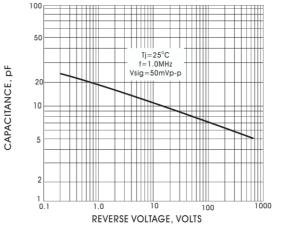


Fig. 6- TYPICL JUNCTION CAPACITANCE PER ELEMENT